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CLAIMS

What is claimed is:

1. A system for removing a contaminant layer from a surface of a semiconductor process component, the system comprising:

- a. a receptacle receiving the component and a first volume of liquid, the liquid selected to remove the contaminant layer; and
- b. at least one liquid-displacing element immersed in the liquid, the at least one liquid-displacing element displacing a second volume greater than half the first volume.
- 2. The system of claim 1, wherein the at least one liquiddisplacing element includes a plurality of liquiddisplacing elements.
- 3. The system of claim 2, wherein liquid-displacing elements moves freely within the liquid.
- 4. The system of claim 2, wherein the plurality of liquid-displacing elements are spherical.
- 5. The system of claim 2, wherein ones of the plurality of liquid-displacing elements are of different sizes.
- 6. The system of claim 2, wherein the displacement elements number at least one hundred.
- 7. The system of claim 1, wherein the component displaces a component volume less than the second volume.
- 8. The system of claim 2, wherein the at least one liquid-Express Mail No.: ET203108735US

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displacing element defines a cavity receiving the component.

- 9. The system of claim 8, wherein the component is of a shape, and wherein the cavity matches the shape.
- 10. The system of claim 1, further comprising a support, wherein the component is suspended by the support.
- 11. The system of claim 10, wherein the support includes a pommel.
- 12. The system of claim 1, wherein the liquid is of a first density and the liquid-displacing element is of a second density is greater than the first density.
- 13. The system of claim 1, further comprising a cleaning bench receiving the receptacle.
- 14. The system of claim 13, wherein the cleaning bench includes a secondary containment vessel for the liquid.
- 15. The system of claim 13, wherein the receptacle is keyed to fit the cleaning bench.
- 16. The system of claim 13, further comprising a second receptacle.
- 17. The system of claim 13, wherein the receptacle includes a first inlet connector and the bench includes a second inlet connector mating with the first inlet connector, the first and second inlet connectors passing the liquid from the bench to the receptacle.

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18. The system of claim 17, wherein removing the receptacle from the bench disconnects the first inlet connector from the second inlet connector.

- 19. The system of claim 17, wherein the receptacle includes a first drain connector and the bench includes a second drain connector mating with the first drain connector, the first and second drain connectors passing the liquid from the receptacle to the bench.
- 20. The system of claim 1, wherein the at least one liquid-displacing element is of a material that will not react with the liquid.